

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Vernon M. Williams and
Michael D. Gifford

Attorney Docket No.: 501062.01

Filed : Concurrently Herewith

Title : LEADFRAME AND METHOD FOR REDUCING MOLD COMPOUND ADHESION
PROBLEMS

11000 U.S. PRO
09/974958
10/10/01

GENERAL AUTHORIZATION

Box Patent Application
Commissioner of Patents
Washington, D.C. 20231

Sir:

With respect to the above-identified application, the Commissioner is authorized to charge any fees under 37 C.F.R. §§ 1.16 and 1.17 which may be required and to treat any concurrent or future reply requiring a petition for an extension of time under 37 C.F.R. § 1.136(a)(3) for its timely submission as incorporating a petition therefor for the appropriate length of time and to charge any fees which may be required during the course of prosecution, or credit any overpayment, to Deposit Account No. 50-1266.

Date

October 10, 2001



Edward W. Bulchis
Registration No. 26,847

EWB:dms

1420 Fifth Avenue, Suite 3400
Seattle, WA 98101-4010
(206) 903-8800
Fax (206) 903-8820